

# SE50PAB, SE50PAD, SE50PAG, SE50PAJ

Vishay General Semiconductor

RoHS COMPLIANT

HALOGEN

**FREE** 

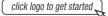
# **Surface-Mount ESD Capability Rectifiers**

# eSMP® Series Top View Bottom View

Anode O Cathode

SMPA (DO-221BC)

### **DESIGN SUPPORT TOOLS**





PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	5.0 A				
V <sub>RRM</sub>	100 V, 200 V, 400 V, 600 V				
I <sub>FSM</sub>	42 A				
$V_F$ at $I_F = 5.0$ A $(T_A = 125  ^{\circ}C)$	0.95 V				
I <sub>R</sub>	10 μΑ				
T <sub>J</sub> max.	175 °C				
Package	SMPA (DO-221BC)				
Circuit configuration	Single				

### **FEATURES**

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- · Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Not recommended for PCB bottom side wave mounting
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

### **TYPICAL APPLICATIONS**

General purpose, power line polarity protection, in both consumer and automotive applications.

### **MECHANICAL DATA**

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	SE50PAB	SE50PAD	SE50PAG	SE50PAJ	UNIT
Device marking code		50B	50D	50G	50J	
Maximum repetitive peak reverse voltage	$V_{RRM}$	100	200	400	600	V
Maximum DC forward current	I <sub>F</sub> <sup>(1)</sup>	5.0				Α
Maximum DC forward current	I <sub>F</sub> <sup>(2)</sup>	1.6				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	42			Α	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +175				°C

### Notes

- (1) Mounted on 30 mm x 30 mm pad areas, aluminum PCB
- (2) Free air, mounted on recommended copper pad area



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 2.5 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.94	-	V
	$I_F = 5.0 A$			1.03	1.16	
	I <sub>F</sub> = 2.5 A	- T <sub>A</sub> = 125 °C		0.84	-	
	$I_F = 5.0 \text{ A}$			0.95	1.10	
Reverse current	Rated V <sub>R</sub>	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	10	μΑ
	nateu v <sub>R</sub>	T <sub>A</sub> = 125 °C		13	150	
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t <sub>rr</sub>	2.0	-	μs
Typical junction capacitance	4.0 V, 1 MHz		CJ	32	-	pF

### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: Pulse width  $\leq$  40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °c unless otherwise noted)						
PARAMETER SYMBOL SE50PAB SE50PAG SE50PAJ UN					UNIT	
Typical thermal registeres		115			°C/W	
Typical thermal resistance	R <sub>0JM</sub> (2)	7			C/VV	

### Notes

 $^{(1)}$  Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient

<sup>(2)</sup> Mounted on 30 mm x 30 mm pad areas aluminum PCB;  $R_{\theta JM}$  - junction to mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ( $T_A = 25~^{\circ}\text{C}$ unless otherwise noted)						
STANDARD	TANDARD TEST TYPE TEST CONDITIONS SYMBOL CLASS VALUE					
AEC-Q101-001 Human body model (contact mode) $C = 100 \text{ pF}, R = 1.5 \text{ k}\Omega$ $V_C$ H3B $> 8 \text{ kV}$					> 8 kV	

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
SE50PAJ-M3/I	0.033	I	14 000	13" diameter plastic tape and reel	
SE50PAJHM3/I (1)	0.033	I	14 000	13" diameter plastic tape and reel	

### Note

(1) AEC-Q101 qualified



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### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

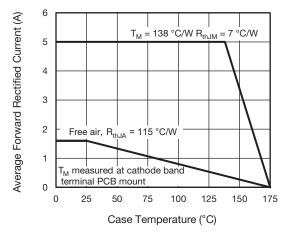


Fig. 1 - Maximum Forward Current Derating Curve

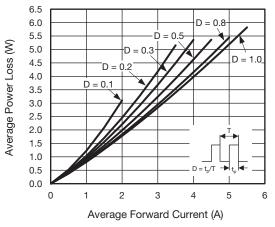


Fig. 2 - Forward Power Loss Characteristics

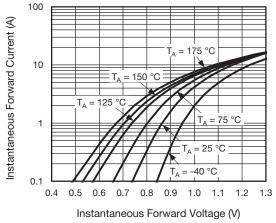


Fig. 3 - Typical Instantaneous Forward Characteristics

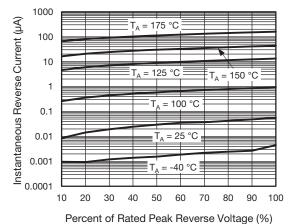


Fig. 4 - Typical Reverse Leakage Characteristics

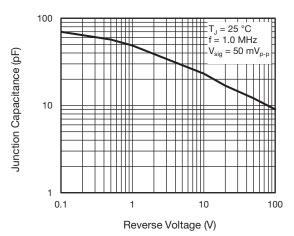


Fig. 5 - Typical Junction Capacitance

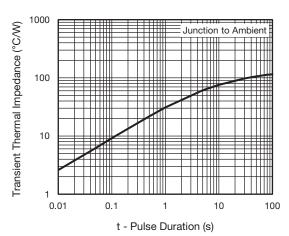


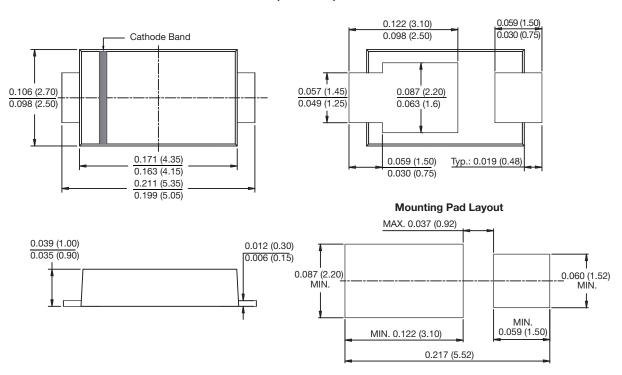
Fig. 6 - Typical Transient Thermal Impedances

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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

### **SMPA (DO-221BC)**





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